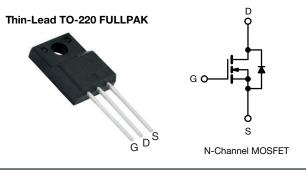
Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	850				
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V 0.25				
Q _g max. (nC)	122				
Q _{gs} (nC)	14				
Q _{gd} (nC)	23				
Configuration	Single				

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION				
Package Thin-Lead TO-220 FULLPAK				
Lead (Pb)-free	SiHA17N80E-E3			
Lead (Pb)-free and halogen-free	SiHA17N80E-GE3			

ABSOLUTE MAXIMUM RATINGS ($T_c = 25 \degree C$, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	800	v	
Gate-source voltage			V _{GS}	± 30	V	
Continuous drain surrent $(T_{1} - 150 \circ C)^{\frac{1}{2}}$	V at 10 V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$	C I _D	6		
Continuous drain current (T _J = 150 °C) ^e	V _{GS} at 10 V	T _C = 100 °C		4	А	
Pulsed drain current ^a			I _{DM}	45		
Linear derating factor				0.28	W/°C	
Single pulse avalanche energy ^b			E _{AS}	353	mJ	
Maximum power dissipation			PD	35	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	$T_J = 125 \text{ °C}$		d\//dt	70	1//20	
Reverse diode dV/dt ^d			dV/dt	5.1	V/ns	
Soldering recommendations (peak temperature) ^c	For 10 s			300	°C	
Mounting torque	M3 screw			0.6	Nm	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature b. $V_{DD} = 140 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 28.2 mH, $R_g = 25 \Omega$, $I_{AS} = 5.0 \text{ A}$ c. 1.6 mm from case

d. $I_{SD} \leq I_D$, dI/dt = 100 A/µs, starting T_J = 25 °C Limited by maximum junction temperature e.

S21-0729-Rev. C, 12-Jul-2021

1



COMPLIANT

HALOGEN

FREE

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SiHA17N80E

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THERMAL RESISTANCE RAT	INGS							
PARAMETER	SYMBOL	TYP.		MAX.	MAX.		UNIT	
Maximum junction-to-ambient	R _{thJA}	- 65		80AM				
Maximum junction-to-case (drain)	R _{thJC}	- 3.6				°C/W		
SPECIFICATIONS (T _J = 25 $^{\circ}$ C, u	unless otherwi	se noted)						
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static								
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 μΑ	800	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	I _D = 1 mA	-	1.08	-	V/°C
Gate-source threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D =	250 µA	2.0	-	4.0	V
		$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA	
Gate-source leakage	I _{GSS}		$V_{GS} = \pm 30$	V	-	-	± 1	μA
Zere gete veltage drain ourrent		V _{DS} =	= 800 V, V _C	_{as} = 0 V	-	-	1	<u>,</u>
Zero gate voltage drain current	IDSS	V _{DS} = 640 V	/, V _{GS} = 0 '	V, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I	_D = 8.5 A	-	0.25	0.29	Ω
Forward transconductance	9 _{fs}	V _{DS} :	= 30 V, I _D :	= 8.5 A	-	8.7	-	S
Dynamic								
Input capacitance	C _{iss}		V _{GS} = 0 \	/.	-	2408	-	
Output capacitance	C _{oss}	$V_{DS} = 100 V,$ f = 1 MHz		-	81	-	pF	
Reverse transfer capacitance	C _{rss}			-	9	-		
Effective output capacitance, energy related ^a	C _{o(er)}	$V_{DS} = 0 V$ to 480 V, $V_{GS} = 0 V$		-	58	-		
Effective output capacitance, time related ^b	C _{o(tr)}			-	296	-		
Total gate charge	Qg				-	61	122	1
Gate-source charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 8.5 \text{ A}, V_{DS} = 480 \text{ V}$		-	14	-	nC	
Gate-drain charge	Q _{gd}				-	23	-	
Turn-on delay time	t _{d(on)}				-	22	44	
Rise time	t _r	Vpp -	- 480 V In	- 8 5 A	-	24	48	
Turn-off delay time	t _{d(off)}	V_{DD} = 480 V, I _D = 8.5 A, V _{GS} = 10 V, R _g = 9.1 Ω		-	71	142	ns	
Fall time	t _f			-	26	52		
Gate input resistance	R _g	f = 1 MHz, open drain		0.3	0.7	1.4	Ω	
Drain-Source Body Diode Characteristi	cs							
Continuous source-drain diode current	۱ _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	15		
Pulsed diode forward current	I _{SM}			-	-	45	A	
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 8.5 A, V _{GS} = 0 V		-	-	1.2	V	
Reverse recovery time	t _{rr}				-	416	832	ns
Reverse recovery charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 8.5 \text{ A},$ dl/dt = 100 A/µs, V _R = 25 V		-	6.4	12.8	μC	
Reverse recovery current	I _{RRM}			-	27	-	A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 V to 480 V V_{DSS}

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 V to 480 V VDSS

2



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

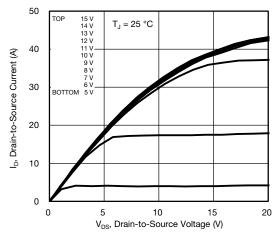


Fig. 1 - Typical Output Characteristics

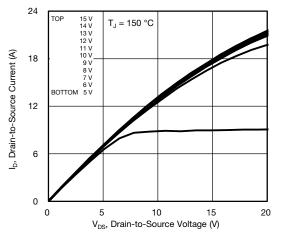


Fig. 2 - Typical Output Characteristics

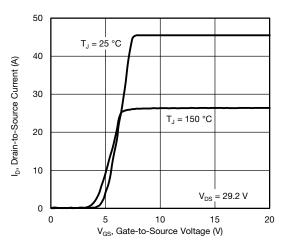


Fig. 3 - Typical Transfer Characteristics

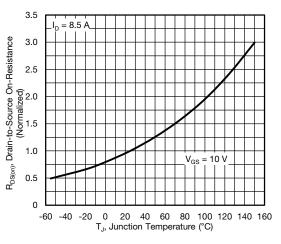


Fig. 4 - Normalized On-Resistance vs. Temperature

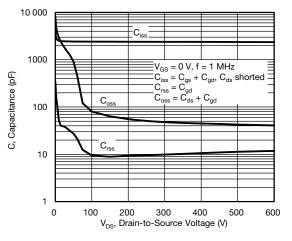


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

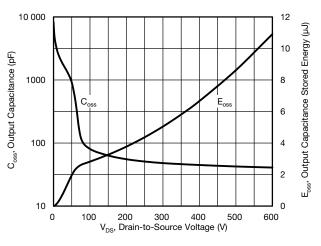


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

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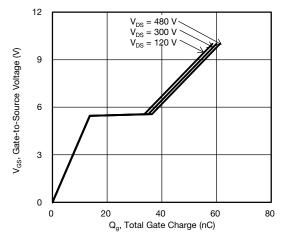


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

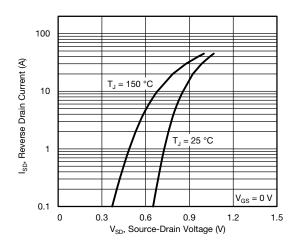


Fig. 8 - Typical Source-Drain Diode Forward Voltage

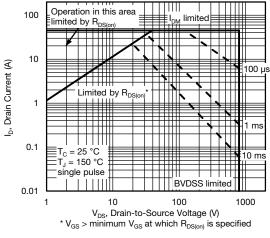


Fig. 9 - Maximum Safe Operating Area

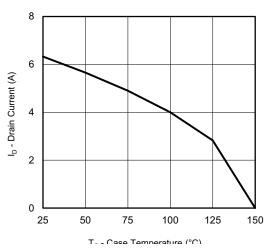


Fig. 10 - Maximum Drain Current vs. Case Temperature

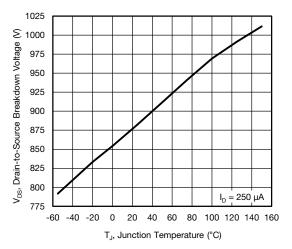


Fig. 11 - Temperature vs. Drain-to-Source Voltage

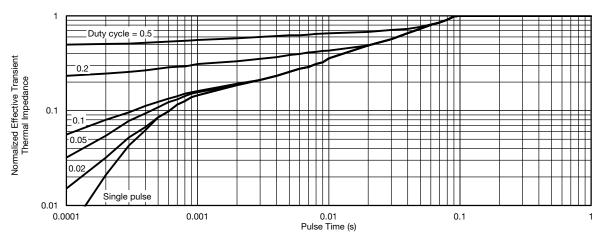
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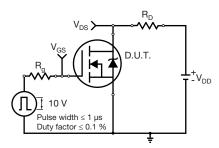


Fig. 13 - Switching Time Test Circuit

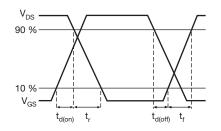


Fig. 14 - Switching Time Waveforms

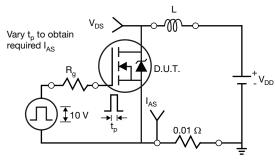


Fig. 15 - Unclamped Inductive Test Circuit

Fig. 16 - Unclamped Inductive Waveforms

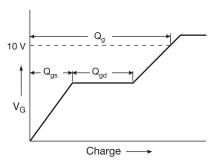


Fig. 17 - Basic Gate Charge Waveform

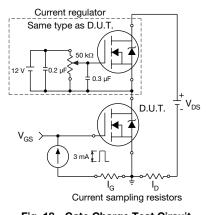


Fig. 18 - Gate Charge Test Circuit

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Peak Diode Recovery dv/dt Test Circuit

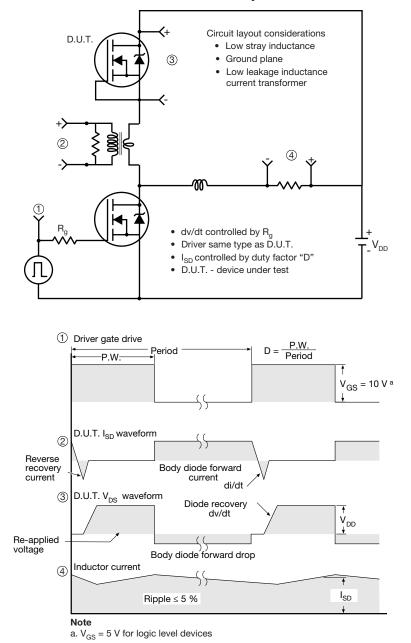


Fig. 19 - For N-Channel

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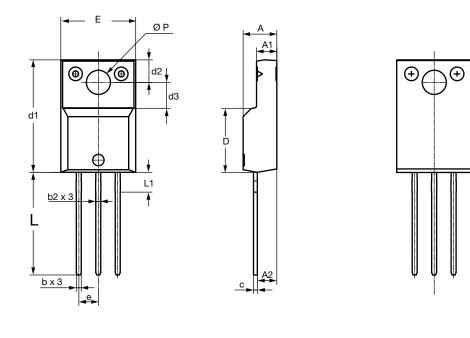
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TO-220 FULLPAK Thin Lead





		DIMEN	ISIONS		
SYMBOL	MILLIN	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
А	4.30	4.70	0.169	0.185	
A1	2.50	2.90	0.098	0.114	
A2	2.40	2.80	0.094	0.110	
b	0.60	0.80	0.024	0.031	
b2	0.60	0.90	0.024	0.035	
С	-	0.60	-	0.024	
D	8.30	8.70	0.327	0.342	
d1	14.70	15.30	0.579	0.602	
d2	2.90	3.10	0.114	0.122	
d3	3.30	3.70	0.130	0.146	
E	9.70	10.30	0.382	0.406	
е	2.50	2.70	0.098	0.106	
L	13.40	13.80	0.528	0.543	
L1	1.00	2.80	0.039	0.110	
ØP	3.00	3.40	0.118	0.134	
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	·	·		

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